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SUM70N04-07L

Vishay Siliconix

N-Channel 40-V (D-S) 175 °C MOSFET

PRODUCT SUMMARY

| $V_{(BR)DSS}$ (V) | $r_{DS(on)}$ (Ω) | I_D (A) |
|-------------------|---------------------------|-----------------|
| 40 | 0.0074 at $V_{GS} = 10$ V | 70 ^a |
| | 0.011 at $V_{GS} = 4.5$ V | 67 |

FEATURES

- TrenchFET® Power MOSFET
- 175 °C Junction Temperature
- Low Threshold

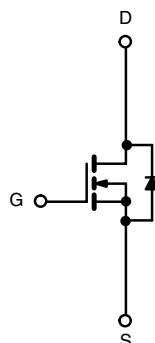
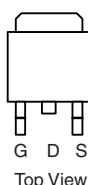


Available
RoHS*
COMPLIANT

APPLICATIONS

- Motor Control

TO-263



Ordering Information: SUM70N04-07L-E3 (Lead (Pb)-free)

N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_C = 25$ °C, unless otherwise noted

| Parameter | Symbol | Limit | Unit |
|--|----------------|------------------|------|
| Drain-Source Voltage | V_{DS} | 40 | V |
| Gate-Source Voltage | V_{GS} | ± 20 | |
| Continuous Drain Current ($T_J = 175$ °C) | I_D | 70 ^a | A |
| | | 47 | |
| Pulsed Drain Current | I_{DM} | 120 | |
| Avalanche Current | I_{AR} | 40 | mJ |
| Repetitive Avalanche Energy ^b | E_{AR} | 80 | |
| Maximum Power Dissipation ^b | P_D | 100 ^c | W |
| | | 3.75 | |
| Operating Junction and Storage Temperature Range | T_J, T_{stg} | - 55 to 175 | °C |

THERMAL RESISTANCE RATINGS

| Parameter | Symbol | Limit | Unit |
|---------------------|------------|-------|------|
| Junction-to-Ambient | R_{thJA} | 40 | °C/W |
| Junction-to-Case | R_{thJC} | 1.4 | |

Notes:

a. Package limited.

b. Duty cycle ≤ 1 %.

c. See SOA curve for voltage derating.

d. When Mounted on 1" square PCB (FR-4 material).

* Pb containing terminations are not RoHS compliant, exemptions may apply.

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| SPECIFICATIONS T _J = 25 °C, unless otherwise noted | | | | | | |
|--|----------------------|--|------|--------|--------|------|
| Parameter | Symbol | Test Conditions | Min. | Typ. | Max. | Unit |
| Static | | | | | | |
| Drain-Source Breakdown Voltage | V _{(BR)DSS} | V _{DS} = 0 V, I _D = 250 μA | 40 | | | V |
| Gate-Threshold Voltage | V _{GS(th)} | V _{DS} = V _{GS} , I _D = 250 μA | 1 | | 3 | |
| Gate-Body Leakage | I _{GSS} | V _{DS} = 0 V, V _{GS} = ± 20 V | | | 100 | nA |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = 32 V, V _{GS} = 0 V | | | 1 | μA |
| | | V _{DS} = 32 V, V _{GS} = 0 V, T _J = 125 °C | | | 50 | |
| | | V _{DS} = 32 V, V _{GS} = 0 V, T _J = 175 °C | | | 250 | |
| On-State Drain Current ^a | I _{D(on)} | V _{DS} ≥ 5 V, V _{GS} = 10 V | 100 | | | A |
| Drain-Source On-State Resistance ^a | r _{DS(on)} | V _{GS} = 10 V, I _D = 30 A | | 0.006 | 0.0074 | Ω |
| | | V _{GS} = 4.5 V, I _D = 10 A | | 0.0085 | 0.011 | |
| | | V _{GS} = 10 V, I _D = 30 A, T _J = 125 °C | | | 0.012 | |
| | | V _{GS} = 10 V, I _D = 30 A, T _J = 175 °C | | | 0.015 | |
| Forward Transconductance ^a | g _{fs} | V _{DS} = 15 V, I _D = 30 A | 20 | | | S |
| Dynamic ^b | | | | | | |
| Input Capacitance | C _{iss} | V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz | | 2800 | | pF |
| Output Capacitance | C _{oss} | | | 320 | | |
| Reverse Transfer Capacitance | C _{rss} | | | 190 | | |
| Total Gate Charge ^c | Q _g | V _{DS} = 20 V, V _{GS} = 10 V, I _D = 50 A | | 50 | 75 | nC |
| Gate-Source Charge ^c | Q _{gs} | | | 10 | | |
| Gate-Drain Charge ^c | Q _{gd} | | | 10 | | |
| Gate Resistance | R _G | | | 2.0 | | Ω |
| Turn-On Delay Time ^c | t _{d(on)} | V _{DD} = 20 V, R _L = 0.4 Ω I _D ≡ 50 A, V _{GEN} = 10 V, R _G = 2.5 Ω | | 11 | 20 | ns |
| Rise Time ^c | t _r | | | 20 | 30 | |
| Turn-Off Delay Time ^c | t _{d(off)} | | | 40 | 60 | |
| Fall Time ^c | t _f | | | 15 | 25 | |
| Source-Drain Diode Ratings and Characteristics T _C = 25 °C ^b | | | | | | |
| Continuous Current | I _S | | | | 66 | A |
| Pulsed Current | I _{SM} | | | | 100 | |
| Forward Voltage ^a | V _{SD} | I _F = 50 A, V _{GS} = 0 V | | 1.0 | 1.5 | V |
| Reverse Recovery Time | t _{rr} | I _F = 50 A, di/dt = 100 A/μs | | 30 | 50 | ns |
| Peak Reverse Recovery Current | I _{RM(REC)} | | | 1.6 | 2.4 | A |
| Reverse Recovery Charge | Q _{rr} | | | | 0.024 | 0.06 |

Notes:

a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

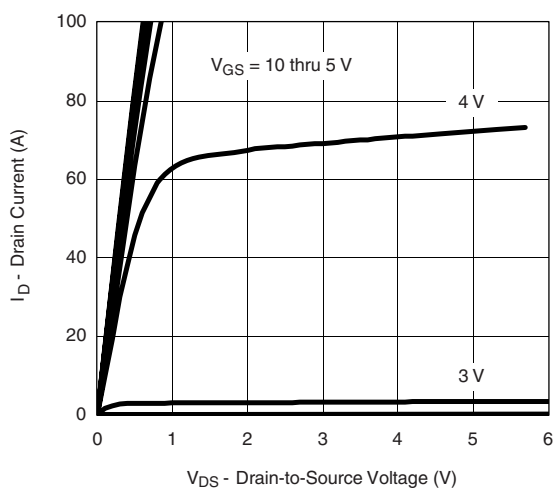
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



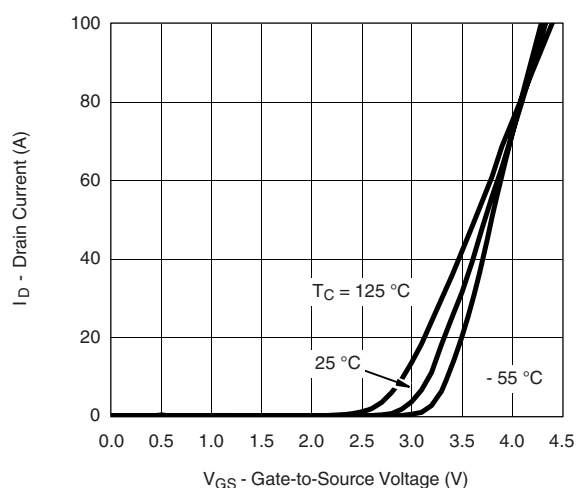
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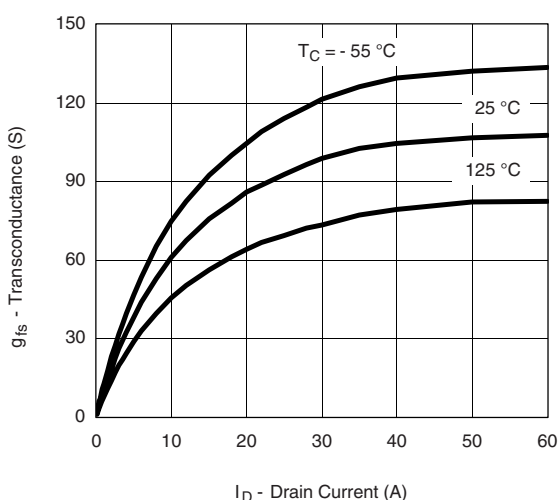
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



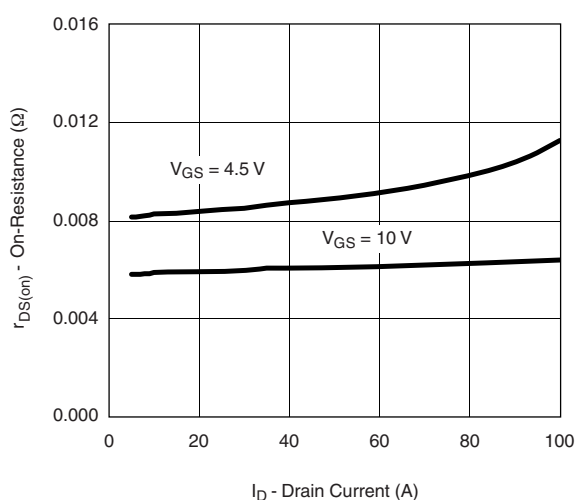
Output Characteristics



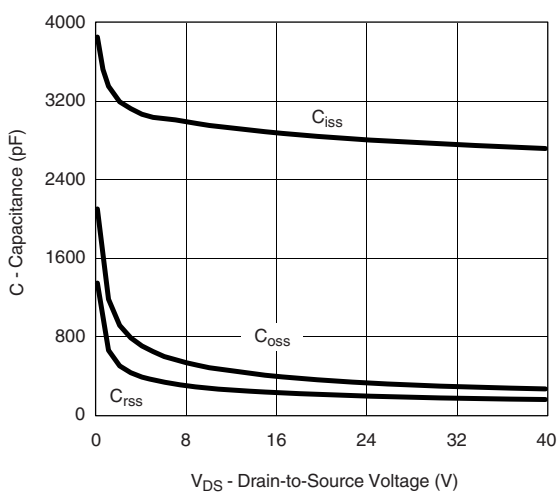
Transfer Characteristics



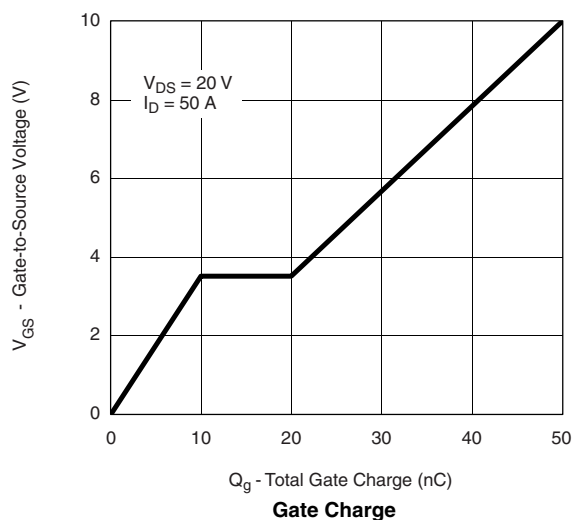
Transconductance



On-Resistance vs. Drain Current



Capacitance



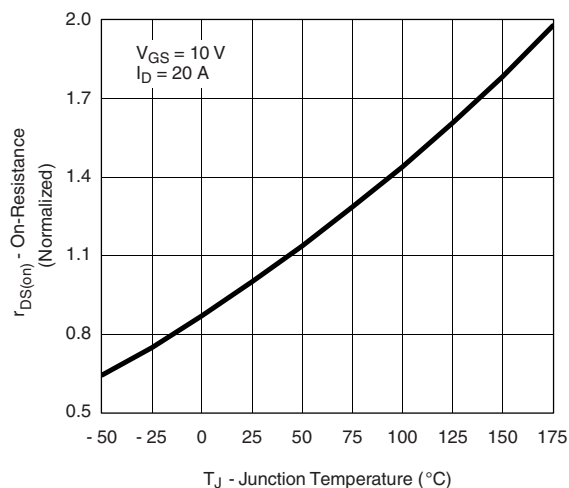
Gate Charge

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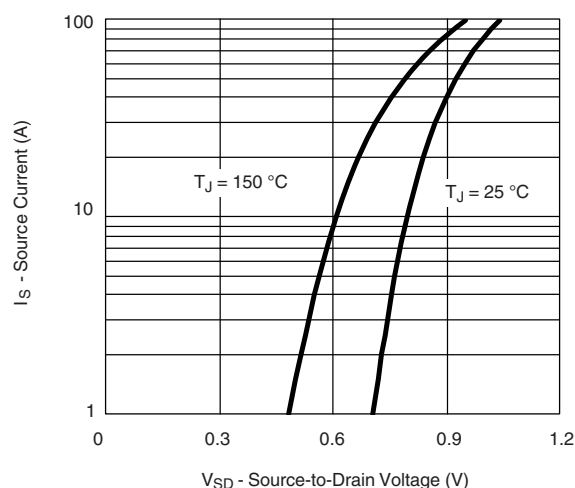
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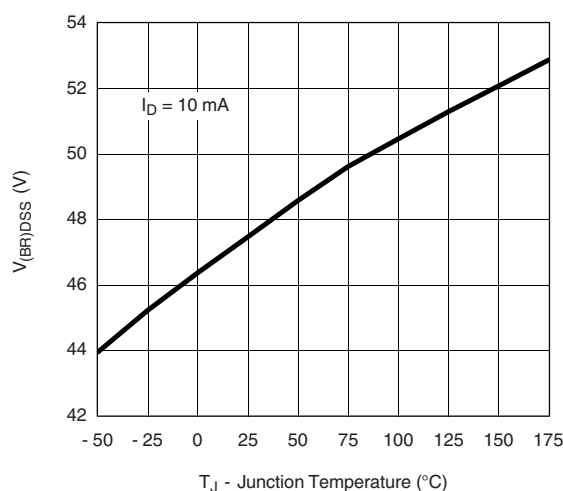
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



On-Resistance vs. Junction Temperature



Source-Drain Diode Forward Voltage



T_J - Junction Temperature ($^{\circ}C$)

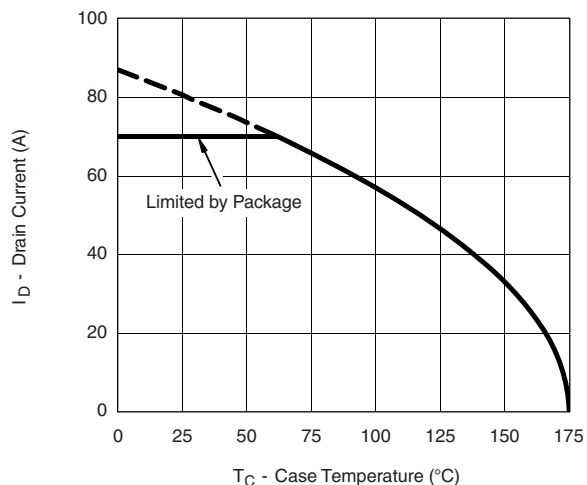
Drain Source Breakdown vs. Junction Temperature



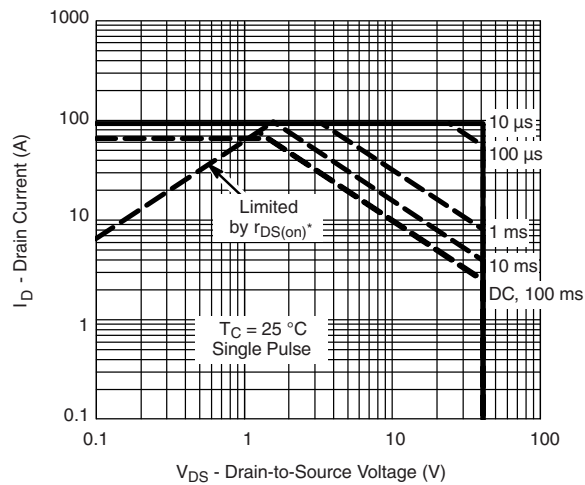
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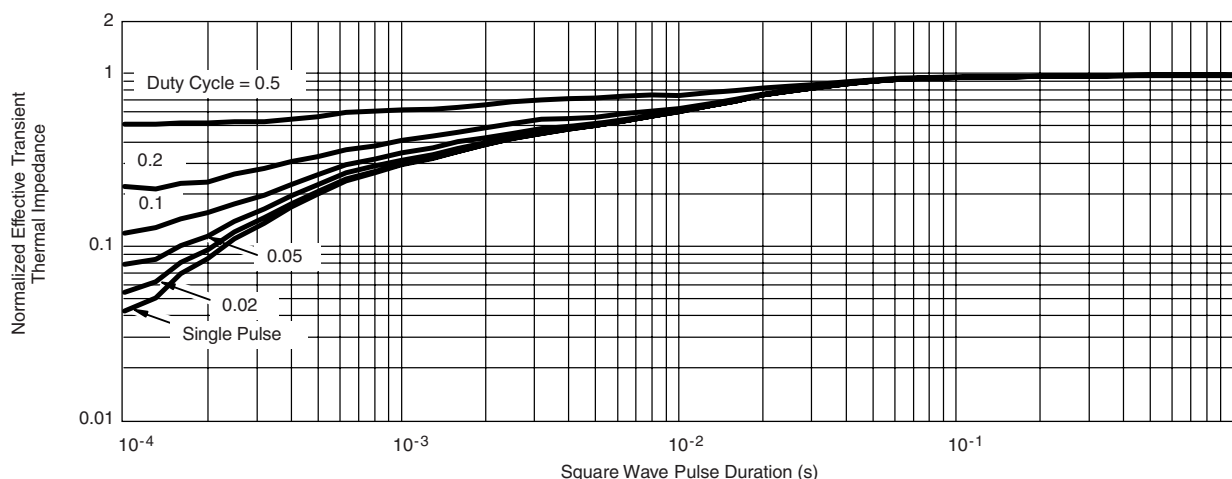
THERMAL RATINGS



Maximum Avalanche and Drain Current vs. Case Temperature



Safe Operating Area, Junction-to-Case



Normalized Thermal Transient Impedance, Junction-to-Case

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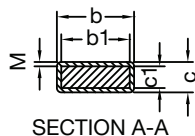
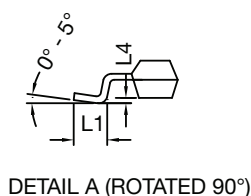
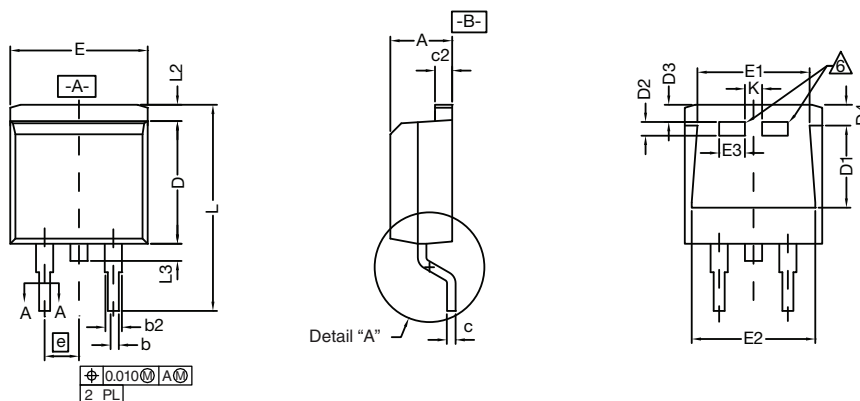


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Package Information

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TO-263 (D²PAK): 3-LEAD



| DIM. | | INCHES | | MILLIMETERS | |
|------|------------|-----------|-------|-------------|--------|
| | | MIN. | MAX. | MIN. | MAX. |
| A | | 0.160 | 0.190 | 4.064 | 4.826 |
| b | | 0.020 | 0.039 | 0.508 | 0.990 |
| b1 | | 0.020 | 0.035 | 0.508 | 0.889 |
| b2 | | 0.045 | 0.055 | 1.143 | 1.397 |
| c* | Thin lead | 0.013 | 0.018 | 0.330 | 0.457 |
| | Thick lead | 0.023 | 0.028 | 0.584 | 0.711 |
| c1 | Thin lead | 0.013 | 0.017 | 0.330 | 0.431 |
| | Thick lead | 0.023 | 0.027 | 0.584 | 0.685 |
| c2 | | 0.045 | 0.055 | 1.143 | 1.397 |
| D | | 0.340 | 0.380 | 8.636 | 9.652 |
| D1 | | 0.220 | 0.240 | 5.588 | 6.096 |
| D2 | | 0.038 | 0.042 | 0.965 | 1.067 |
| D3 | | 0.045 | 0.055 | 1.143 | 1.397 |
| D4 | | 0.044 | 0.052 | 1.118 | 1.321 |
| E | | 0.380 | 0.410 | 9.652 | 10.414 |
| E1 | | 0.245 | - | 6.223 | - |
| E2 | | 0.355 | 0.375 | 9.017 | 9.525 |
| E3 | | 0.072 | 0.078 | 1.829 | 1.981 |
| e | | 0.100 BSC | | 2.54 BSC | |
| K | | 0.045 | 0.055 | 1.143 | 1.397 |
| L | | 0.575 | 0.625 | 14.605 | 15.875 |
| L1 | | 0.090 | 0.110 | 2.286 | 2.794 |
| L2 | | 0.040 | 0.055 | 1.016 | 1.397 |
| L3 | | 0.050 | 0.070 | 1.270 | 1.778 |
| L4 | | 0.010 BSC | | 0.254 BSC | |
| M | | - | 0.002 | - | 0.050 |

ECN: T13-0707-Rev. K, 30-Sep-13
DWG: 5843

Notes

- Plane B includes maximum features of heat sink tab and plastic.
- No more than 25 % of L1 can fall above seating plane by max. 8 mils.
- Pin-to-pin coplanarity max. 4 mils.
- *: Thin lead is for SUB, SYB.
Thick lead is for SUM, SYM, SQM.
- Use inches as the primary measurement.
- This feature is for thick lead.

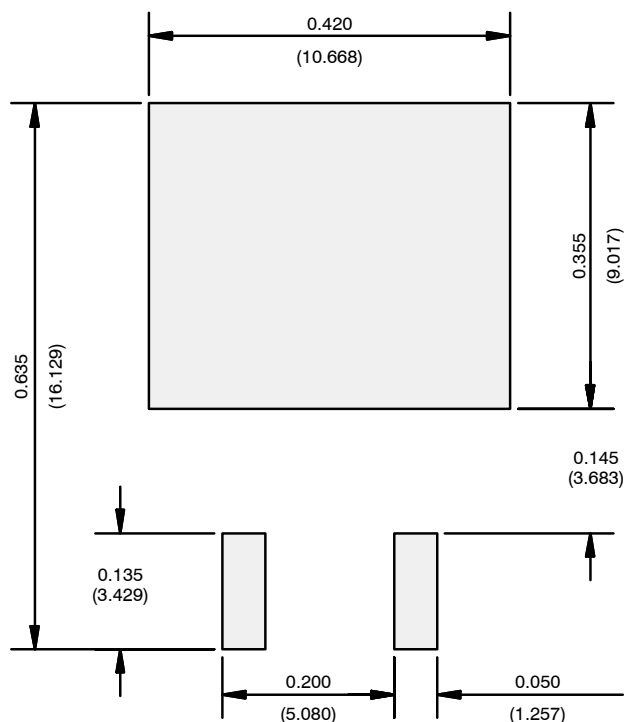
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AN826

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RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads
Dimensions in Inches/(mm)

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